TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HC02AP, TC74HC02AF

#### Quad 2-Input NOR Gate

The TC74HC02A is a high speed CMOS 2-INPUT NOR GATE fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

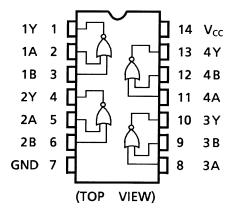
The internal circuit is composed of 3 stages, including a buffer output, which provide high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

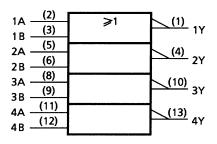
#### **Features**

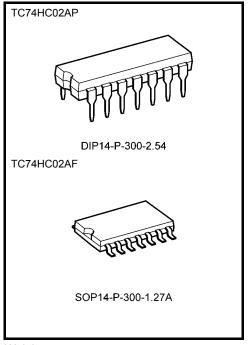
- High speed:  $t_{pd} = 6$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 1 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 4 mA (min)
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2 to 6 V
- Pin and function compatible with 74LS02

#### **Pin Assignment**



#### **IEC Logic Symbol**





Weight

DIP14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.)

Start of commercial production 1986-05

#### **Truth Table**

Α	В	Υ
L	L	Н
L	Н	L
Н	L	L
Н	Н	L

#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of  $Ta = -40^{\circ}C$  to 65°C. From  $Ta = 65^{\circ}C$  to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

#### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	emperature T <sub>opr</sub> -40 to 85		°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics Symbol		Test Condition  V <sub>CC</sub> (V)		Ta = 25°C			Ta = -40 to 85°C		Unit	
					Min	Тур.	Max	Min	Max	
				2.0	1.50	_	_	1.50	_	
High-level input voltage	V <sub>IH</sub>		_		3.15	_	_	3.15	_	V
				6.0	4.20	_	_	4.20	_	
				2.0	_	_	0.50	_	0.50	
Low-level input voltage	V <sub>IL</sub>		_	4.5	_	_	1.35	_	1.35	V
				6.0	_	_	1.80	_	1.80	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	1.9	_	
				4.5	4.4	4.5	_	4.4	_	
High-level output voltage	V <sub>OH</sub>			6.0	5.9	6.0	_	5.9	_	V
			I <sub>OH</sub> = -4 mA	4.5	4.18	4.31	_	4.13	_	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_	
				2.0	_	0.0	0.1	_	0.1	
			$I_{OL}=20~\mu A$	4.5	_	0.0	0.1	_	0.1	
Low-level output voltage	V <sub>OL</sub>	= V <sub>IH</sub> or V <sub>IL</sub>		6.0	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	_	0.33	
			$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	±0.1	_	±1.0	μА
Quiescent supply current	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	_	1.0	_	10.0	μА

## AC Characteristics (C<sub>L</sub> = 15 pF, V<sub>CC</sub> = 5 V, Ta = 25°C, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>	_	_	4	8	ns
	t <sub>THL</sub>					
Propagation delay time	t <sub>pLH</sub>			6	12	ns
	$t_{pHL}$	_			12	113



## AC Characteristics ( $C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics Symb	Symbol	bol Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	,			Min	Тур.	Max	Min	Max	
	4		2.0	_	25	75	_	95	
Output transition time	t <sub>TLH</sub>	_	4.5	_	7	15	_	19	ns
	t <sub>THL</sub>		6.0	_	6	13	_	16	
			2.0	_	27	75	_	95	
Propagation delay tpLH time tpHL	-	_	4.5	_	9	15	_	19	ns
	lрНL		6.0	_	8	13	_	16	
Input capacitance	C <sub>IN</sub>	_		_	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	_		_	21	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

4

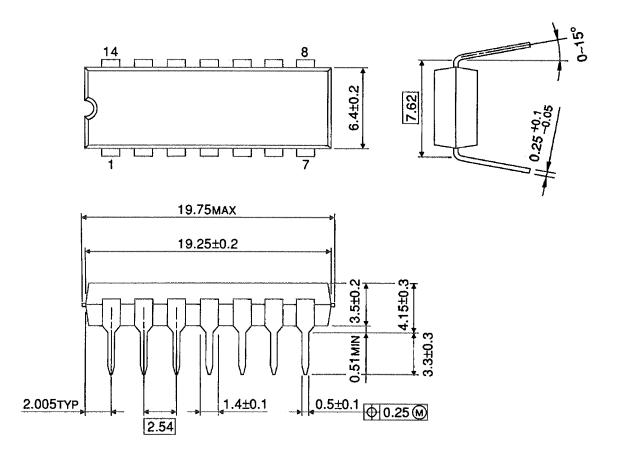
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4$  (per gate)



## **Package Dimensions**

DIP14-P-300-2.54 Unit: mm

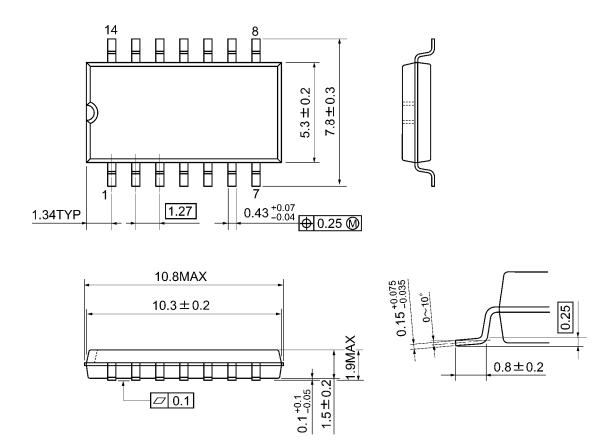


Weight: 0.96 g (typ.)



### **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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2014-03-01